

Material - Metal	Brass
Material - Plating Mating	Tin
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	2.049/g
Number of Rows	1
Orientation	Right Angle
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	1.60mm
Packaging Type	Tray
Pitch - Mating Interface	3.00mm
Plating min - Mating	2.540μm
Plating min - Termination	2.540μm
Polarized to PCB	Yes
Shrouded	Fully
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-40° to +105°C
Termination Interface: Style	Through Hole
Electrical	
Current - Maximum per Contact	8.5A
Voltage - Maximum	600V
Solder Process Data	
Duration at Max. Process Temperature (seconds)	030
Lead-freeProcess Capability	SMC&WAVE
Max. Cycles at Max. Process Temperature	003
Process Temperature max. C	260
Material Info	
Reference - Drawing Numbers	
Packaging Specification	PK-70873-0321-001
Product Specification	436500001-PS-JA-000, 436500001-PS-KO-000, 436500001-PS-SP-000, PS-43650-001
Sales Drawing	SD-43650-002-000
Symbol/Footprint Data	SYM-43650-1103-001
Test Summary	430450004-TS-000, TS-43045-001-001, TS-43045-002-001, TS-46235-001-001

This document was generated on 09/13/2021

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION